

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kuo-Chin Lin</td> <td>04/26/2007</td> </tr> <tr> <td>Bo Liu</td> <td>04/26/2007</td> </tr> <tr> <td>Feng Zhu</td> <td>04/26/2007</td> </tr> </tbody> </table>		Name	Execution Date	Kuo-Chin Lin	04/26/2007	Bo Liu	04/26/2007	Feng Zhu	04/26/2007
Name	Execution Date								
Kuo-Chin Lin	04/26/2007								
Bo Liu	04/26/2007								
Feng Zhu	04/26/2007								
RECEIVING PARTY DATA									
Name:	Cheng Uei Precision Industry Co., Ltd.								
Street Address:	No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City,								
City:	Taipei Hsien								
State/Country:	TAIWAN								
Postal Code:	236								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11742498</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11742498				
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Application Number:	11742498								
CORRESPONDENCE DATA									
Fax Number:	(703)205-8050								
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Total Attachments: 2 source=20080228ASSIGNMENT#page1.tif									

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U-AP/03388

ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: **ELECTRICAL CONNECTOR**

the specification of which (check one):

<input checked="" type="checkbox"/>	is executed on even date herewith.	
<input type="checkbox"/>	was filed on (day-month-year)	as U.S. Application Number
<input type="checkbox"/>	was filed on (day-month-year)	as PCT Application Number
<input type="checkbox"/>	was executed on the following date(s)	

WHEREAS, **Cheng Dei Precision Industry Co., Ltd.**

having a postal address of **No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.**

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Full Name of First or Sole Inventor Kuo-Chin Lin	Post Office Address: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Citizenship China	Residence: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Date 04-26-2007	Signature Kuo-Chin, Lin

Full Name of Second or Joint Inventor Bo Liu	Post Office Address: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Citizenship China	Residence: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Date 04-26-2007	Signature Bo Liu

See following page(s) for additional joint inventors.

SUPPLEMENTAL PAGE FOR AN ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

Title:

Full Name of Joint Inventor Feng Zhu	Post Office Address: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Citizenship China	Residence: No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
Date 04-26-2007	Signature Feng Zhu

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence
Date	Signature

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence
Date	Signature

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence
Date	Signature

See following page(s) for additional joint inventors.